2SC3391

Silicon NPN Epitaxial Planar

HITACHI

Application

VHF amplifier, Mixer, Local oscillator

Outline

SPAK



- 1. Emitter
- 2. Collector
- 3. Base



2SC3391

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
Collector to emitter voltage	V _{CEO}	20	V
Emitter to base voltage	V_{EBO}	4	V
Collector current	I _c	20	mA
Collector power dissipation	P _c	200	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

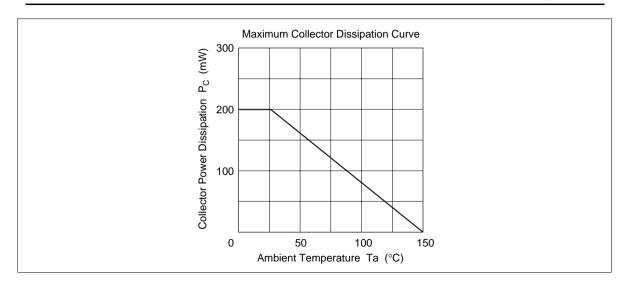
Electrical Characteristics (Ta = 25°C)

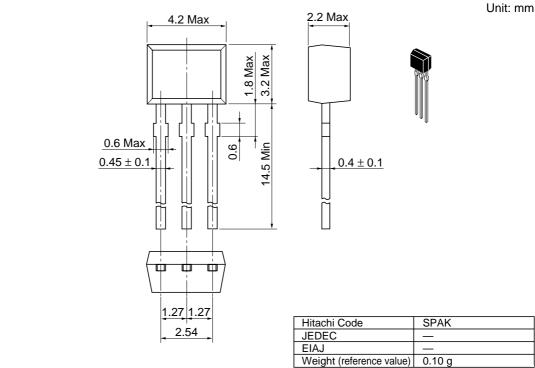
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\text{(BR)CEO}}$	20	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	0.5	μΑ	$V_{CB} = 10 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE} *1	60	_	200		$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Base to emitter voltage	V _{BE}	_	0.72	_	V	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	0.17	_	V	I _C = 20 mA, I _B = 4 mA
Gain bandwidth product	f⊤	450	940	_	MHz	$V_{CE} = 6 \text{ V}, I_{C} = 5 \text{ mA}$
Collector output capacitance	Cob	_	0.9	1.2	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Power gain	PG	17	20	_	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ f = 100 MHz
Noise figure	NF	_	3.5	5.5	dB	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA},$ $R_{q} = 50 \Omega, f = 100 \text{ MHz}$

Note: 1. The 2SC3391 is grouped by h_{FE} as follows.

В	С
60 to 120	100 to 200

See characteristic curves of 2SC535.





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